

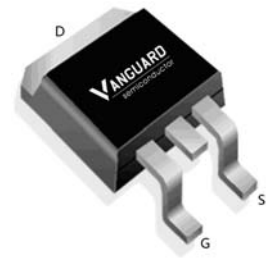
Features

- N-Channel, 10V Logic Level Control
- Enhancement mode
- Very low on-resistance
- Fast Switching
- 100% Avalanche Tested
- Pb-free lead plating; RoHS compliant

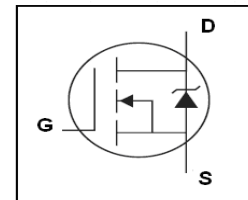


V_{DS}	60	V
$R_{DS(on),TYP}@ V_{GS}=10V$	3.7	mΩ
I_D	140	A

TO-263



Part ID	Package Type	Marking	Tape and reel information
VSM003N06HS	TO-263	003N06H	800pcs/Reel



Maximum ratings, at $T_j=25\text{ }^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Rating	Unit
$V_{(BR)DSS}$	Drain-Source breakdown voltage	60	V
I_S	Diode continuous forward current	$T_C=25\text{ }^\circ\text{C}$	140 A
I_D	Continuous drain current@ $V_{GS}=10V$	$T_C=25\text{ }^\circ\text{C}$	140 A
		$T_C=100\text{ }^\circ\text{C}$	90 A
I_{DM}	Pulse drain current tested ①	$T_C=25\text{ }^\circ\text{C}$	560 A
IAS	Avalanche current	L=0.5mH	48 A
EAS	Avalanche energy, single pulsed ②		100 mJ
P_D	Maximum power dissipation	$T_C=25\text{ }^\circ\text{C}$	175 W
VGS	Gate-Source voltage	±20	V
$T_{STG} T_J$	Storage and operating temperature range	-55 to 175	°C

Thermal Characteristics

Symbol	Parameter	Typical	Unit
$R_{\theta JC}$	Thermal Resistance-Junction to Case	0.85	°C/W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient	48	°C/W

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Static Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
V _{(BR)DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V I _D =250μA	60	--	--	V
I _{DSS}	Zero Gate Voltage Drain Current(T _c =25°C)	V _{DS} =60V,V _{GS} =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(T _c =125°C)	V _{DS} =60V,V _{GS} =0V	--	--	100	μA
I _{GSS}	Gate-Body Leakage Current	V _{GS} =±20V,V _{DS} =0V	--	--	±100	nA
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} =V _{GS} ,I _D =250μA	2.0	3.0	4.0	V
R _{DS(ON)}	Drain-Source On-State Resistance ^③	V _{GS} =10V, I _D =45A	--	3.7	4.5	mΩ
Dynamic Electrical Characteristics @ T_c = 25°C (unless otherwise stated)						
C _{iss}	Input Capacitance	V _{DS} =25V,V _{GS} =0V, f=1MHz	--	5220	--	pF
C _{oss}	Output Capacitance		--	570	--	pF
C _{rss}	Reverse Transfer Capacitance		--	380	--	pF
R _g	Gate Resistance	f=1MHz	--	1.8	--	Ω
Q _g	Total Gate Charge	V _{DS} =30V,I _D =20A, V _{GS} =10V	--	124	--	nC
Q _{gs}	Gate-Source Charge		--	11	--	nC
Q _{gd}	Gate-Drain Charge		--	14	--	nC
Switching Characteristics						
t _{d(on)}	Turn-on Delay Time	V _{DD} =30V, I _D =10A, R _G =3.5Ω, V _{GS} =10V	--	26	--	nS
t _r	Turn-on Rise Time		--	23	--	nS
t _{d(off)}	Turn-Off Delay Time		--	45	--	nS
t _f	Turn-Off Fall Time		--	12	--	nS
Source- Drain Diode Characteristics @ T_c = 25°C (unless otherwise stated)						
V _{SD}	Forward on voltage	I _{SD} =35A,V _{GS} =0V	--	0.83	1.2	V
t _{rr}	Reverse Recovery Time	T _j =25°C,I _{sd} =20A, di/dt=500A/μs	--	32	--	nS
Q _{rr}	Reverse Recovery Charge		--	141	--	nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T_{jmax}, starting T_J = 25°C, L = 0.5mH,R_G = 25Ω, I_{AS} = 20A, V_{GS} = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle ≤ 2%.

Typical Characteristics

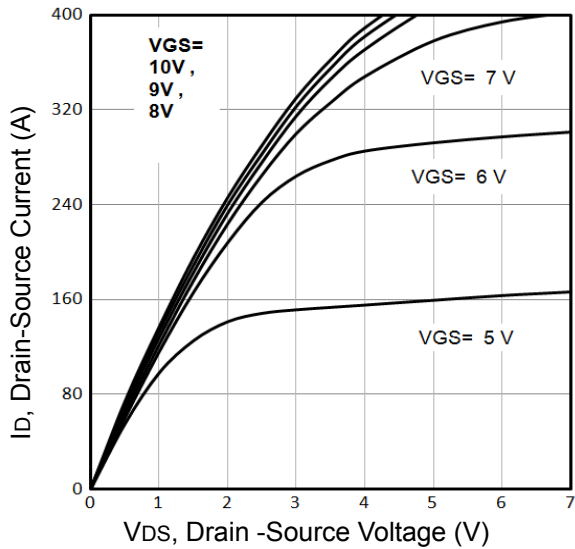


Fig1. Typical Output Characteristics

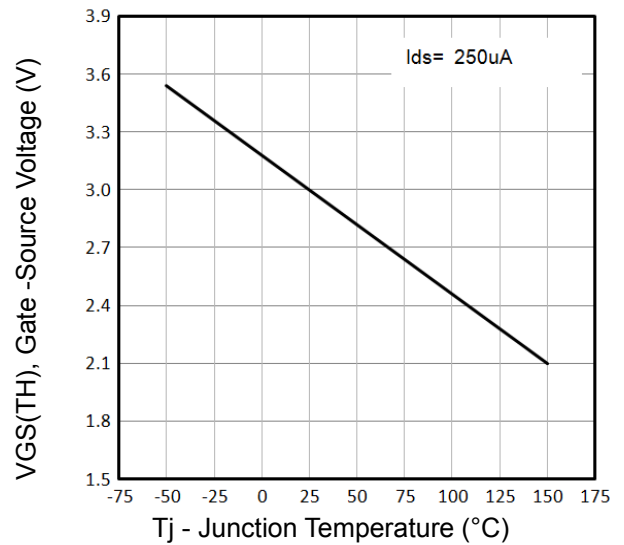


Fig2. $V_{GS(TH)}$ Gate-Source Voltage Vs. T_j

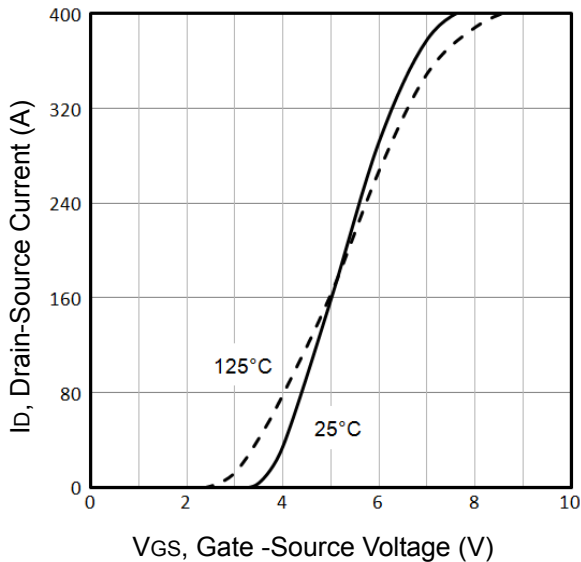


Fig3. Typical Transfer Characteristics

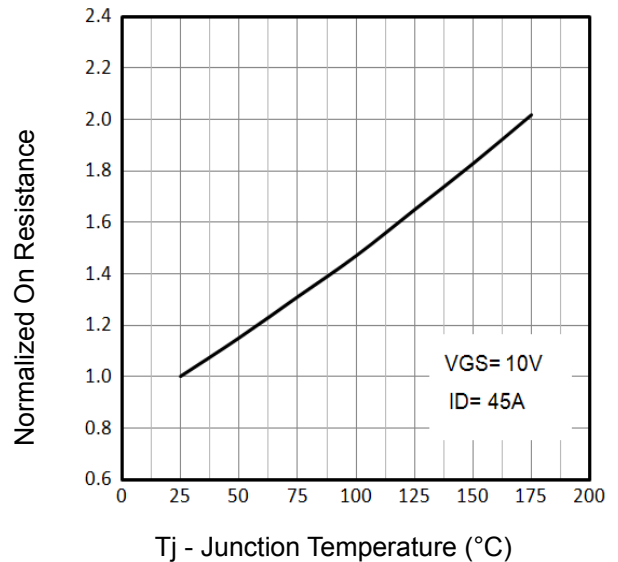


Fig4. Normalized On-Resistance Vs. T_j

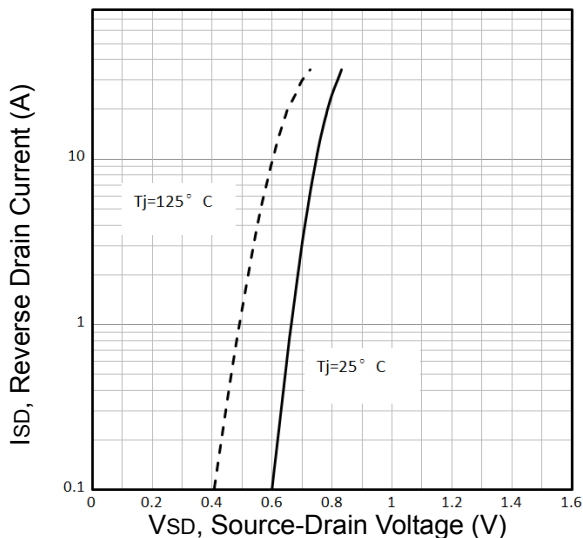


Fig5. Typical Source-Drain Diode Forward Voltage

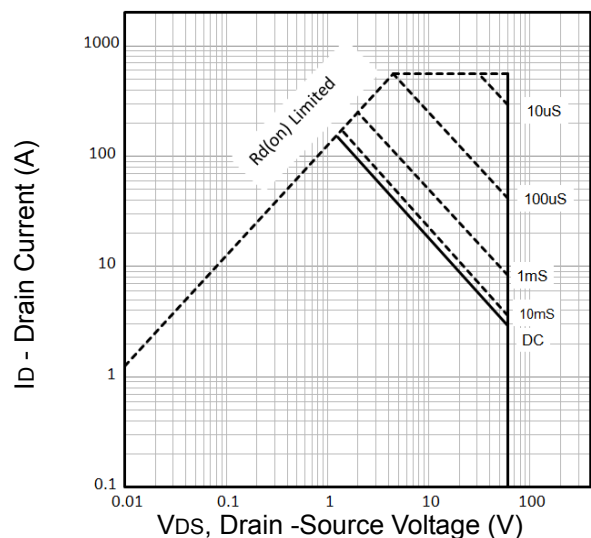


Fig6. Maximum Safe Operating Area

Typical Characteristics

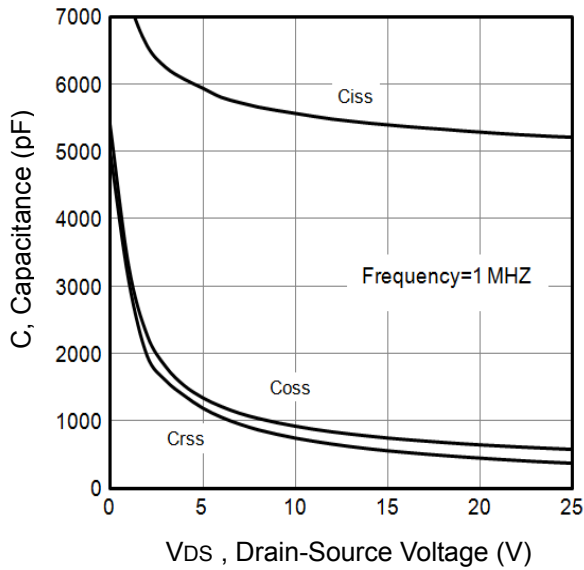


Fig7. Typical Capacitance Vs.Drain-Source Voltage

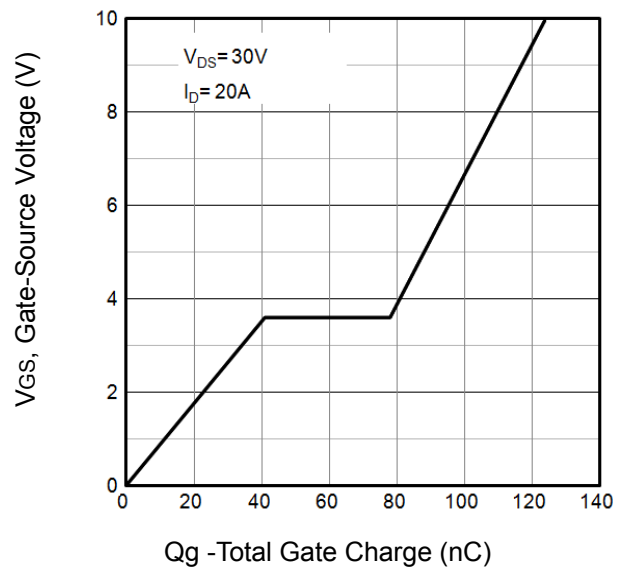


Fig8. Typical Gate Charge Vs.Gate-Source

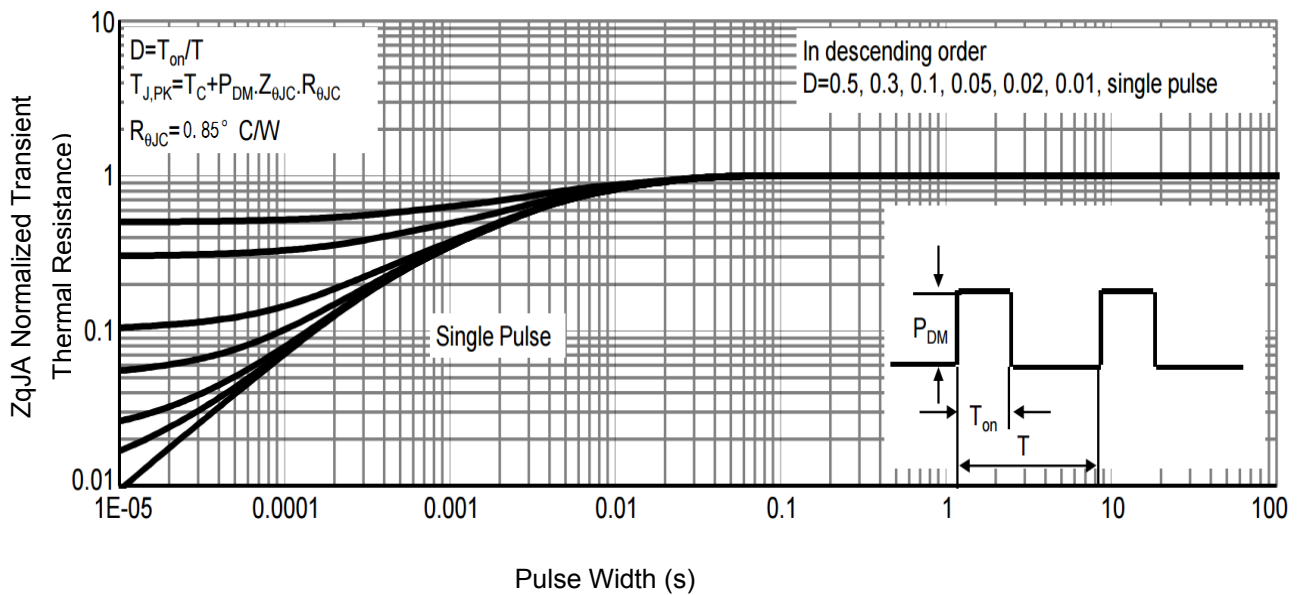


Fig9 . Normalized Maximum Transient Thermal Impedance

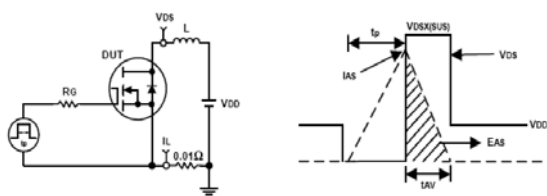


Fig10. Unclamped Inductive Test Circuit and waveforms

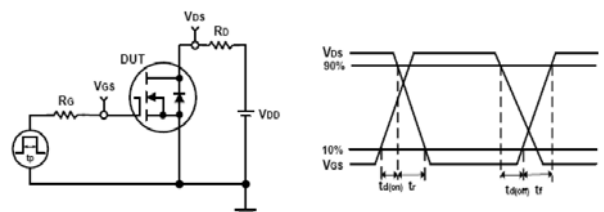
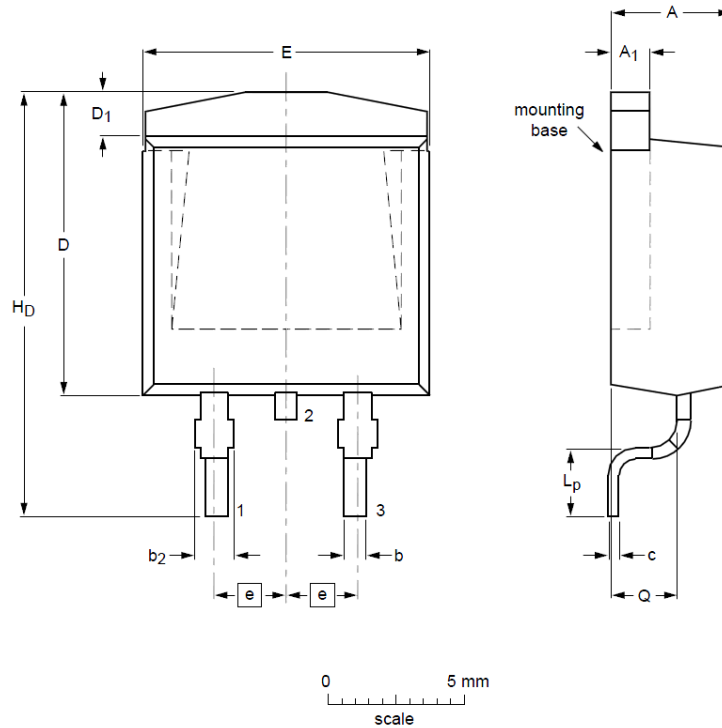


Fig11. Switching Time Test Circuit and waveforms

TO-263 Package Outline Data



DIMENSIONS (unit : mm)

Symbol	Min	Typ	Max	Symbol	Min	Typ	Max
A	4.40	4.55	4.70	A₁	1.25	1.30	1.40
b	0.60	0.76	0.85	b₂	1.05	1.30	1.45
c	0.35	0.45	0.60	D	9.80	10.20	10.50
D₁	1.20	1.51	1.60	E	9.70	10.10	10.30
e	--	2.54	--	H_D	14.80	15.45	15.80
L_P	2.10	2.40	2.90	Q	2.20	2.50	2.60

Customer Service

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